



N-Channel Enhancement-Mode Vertical DMOS FETs

Features

- ▶ Free from secondary breakdown
- ▶ Low power drive requirement
- ▶ Ease of paralleling
- ▶ Low C_{iss} and fast switching speeds
- ▶ Excellent thermal stability
- ▶ Integral source-drain diode
- ▶ High input impedance and high gain

Applications

- ▶ Motor controls
- ▶ Converters
- ▶ Amplifiers
- ▶ Switches
- ▶ Power supply circuits
- ▶ Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

Ordering Information

Part Number	Package Option	Packing
VN3205N3-G	3-Lead TO-92	1000/Bag
VN3205N3-G P002	3-Lead TO-92	2000/Reel
VN3205N3-G P003		
VN3205N3-G P005		
VN3205N3-G P013		
VN3205N3-G P014		
VN3205N8-G	3-Lead TO-243AA (SOT-89)	2000/Reel
VN3205NW	Die in wafer form	---
VN3205NJ	Die on adhesive tape	---
VN3205ND	Die in wafer pack	---

For packaged products, -G indicates package is RoHS compliant ('Green').
TO-92 taping specifications and winding styles per EIA-468 Standard.
Devices in Wafer / Die form are RoHS compliant ('Green').
Refer to Die Specification VF32 for layout and dimensions.

Absolute Maximum Ratings

Parameter	Value
Drain-to-source voltage	BV_{DSS}
Drain-to-gate voltage	BV_{DGS}
Gate-to-source voltage	$\pm 20V$
Operating and storage temperature	$-55^{\circ}C$ to $+150^{\circ}C$

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

Typical Thermal Resistance

Package	θ_{ja}
3-Lead TO-92	$132^{\circ}C/W$
3-Lead TO-243AA (SOT-89)	$133^{\circ}C/W$

General Description

This enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

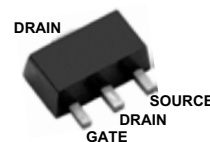
Product Summary

BV_{DSS}/BV_{DGS} (V)	$R_{DS(ON)}$ (max) (Ω)	$V_{GS(th)}$ (max) (V)
50	0.3	2.4

Pin Configuration



TO-92 (N3)



TO-243AA (SOT-89) (N8)

Product Marking

SiVN
3 2 0 5
YYWW

YY = Year Sealed
WW = Week Sealed
— = "Green" Packaging

Package may or may not include the following marks: Si or

TO-92 (N3)

VN2LW

W = Code for week sealed
— = "Green" Packaging

Package may or may not include the following marks: Si or

TO-243AA (SOT-89) (N8)

Thermal Characteristics

Package	I_D (continuous)* (A)	I_D (pulsed) (A)	Power Dissipation @ $T_c = 25^\circ\text{C}$ (W)	$I_{DR}^\dagger$ (A)	I_{DRM} (A)
TO-92	1.2	8.0	1.0	1.2	8.0
TO-243AA	1.5	8.0	1.6 ($T_A = 25^\circ$)	1.5	8.0

Notes:

* I_D (continuous) is limited by max rated T_j , $T_a = 25^\circ\text{C}$.

† Total for package.

$\ddagger$ Mounted on FR5 board, 25mm x 25mm x 1.57mm.

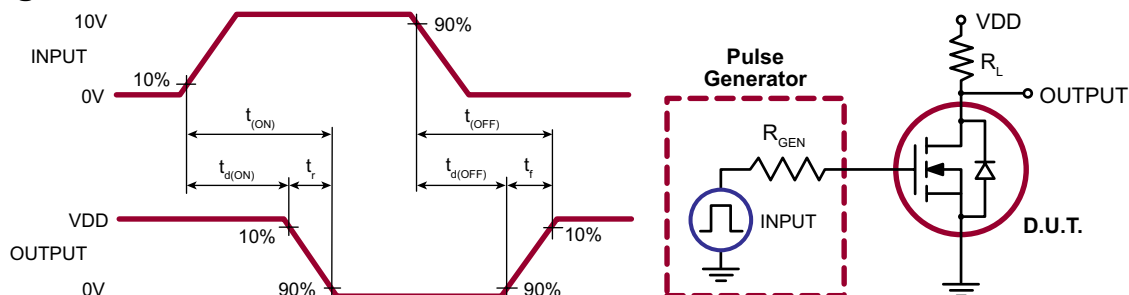
Electrical Characteristics ($T_j = 25^\circ\text{C}$ unless otherwise specified)

Sym	Parameter	Min	Typ	Max	Units	Conditions
BV_{DSS}	Drain-to-Source breakdown voltage	50	-	-	V	$V_{GS} = 0V$, $I_D = 10\text{mA}$
$V_{GS(th)}$	Gate threshold voltage	0.8	-	2.4	V	$V_{GS} = V_{DS}$, $I_D = 10\text{mA}$
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with temperature	-	-4.3	-5.5	mV/ $^\circ\text{C}$	$V_{GS} = V_{DS}$, $I_D = 10\text{mA}$
I_{GSS}	Gate body leakage current	-	1.0	100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$
I_{DSS}	Zero Gate voltage drain current	-	-	10	μA	$V_{GS} = 0V$, $V_{DS} = \text{Max Rating}$
		-	-	1.0	mA	$V_{DS} = 0.8 \text{ Max Rating}$, $V_{GS} = 0V$, $T_A = 125^\circ\text{C}$
$I_{D(ON)}$	ON-state Drain current	3.0	14	-	A	$V_{GS} = 10V$, $V_{DS} = 5.0V$
$R_{DS(ON)}$	Static Drain-to-Source ON-state resistance	TO-92	-	0.45	Ω	$V_{GS} = 4.5V$, $I_D = 1.5A$
		TO-243AA	-	0.45		$V_{GS} = 4.5V$, $I_D = 0.75A$
		TO-92	-	0.3		$V_{GS} = 10V$, $I_D = 3.0A$
		TO-243AA	-	0.3		$V_{GS} = 10V$, $I_D = 1.5A$
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with temperature	-	0.85	1.2	%/ $^\circ\text{C}$	$V_{GS} = 10V$, $I_D = 3.0A$
G_{FS}	Forward transconductance	1.0	1.5	-	mho	$V_{DS} = 25V$, $I_D = 2.0A$
C_{ISS}	Input capacitance	-	220	300	pF	$V_{GS} = 0V$, $V_{DS} = 25V$, $f = 1.0\text{MHz}$
C_{OSS}	Common Source output capacitance	-	70	120		
C_{RSS}	Reverse transfer capacitance	-	20	30		
$t_{d(ON)}$	Turn-on delay time	-	-	10	ns	$V_{DD} = 25V$, $I_D = 2.0A$, $R_{GEN} = 10\Omega$
t_r	Rise time	-	-	15		
$t_{d(OFF)}$	Turn-off delay time	-	-	25		
t_f	Fall time	-	-	25		
V_{SD}	Diode forward voltage drop	-	-	1.6	V	$V_{GS} = 0V$, $I_{SD} = 1.5A$
t_{rr}	Reverse recovery time	-	300	-	ns	$V_{GS} = 0V$, $I_{SD} = 1.0A$

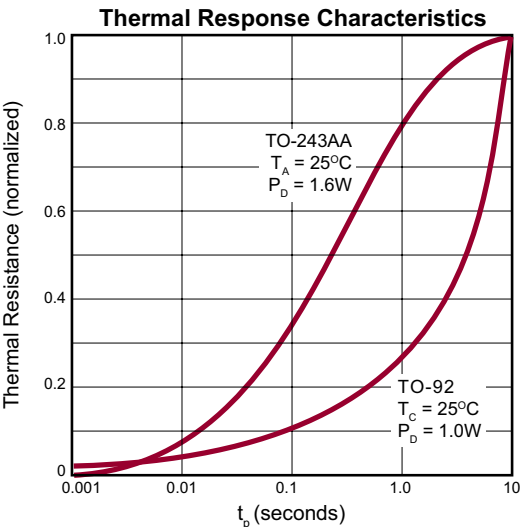
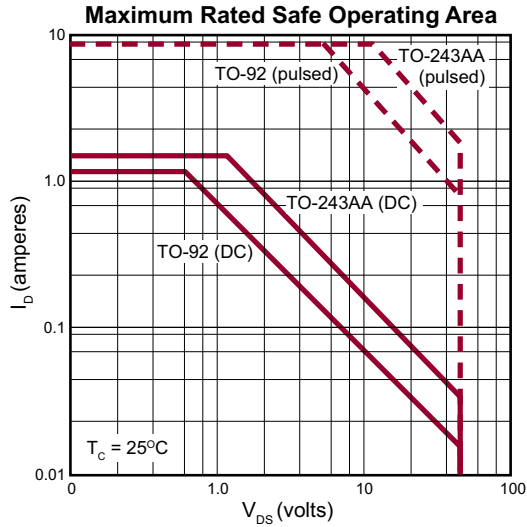
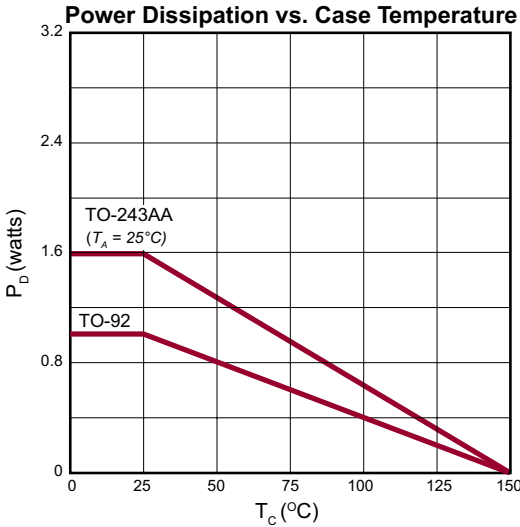
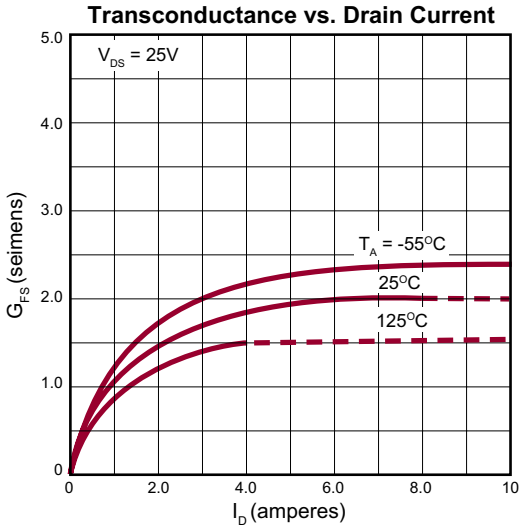
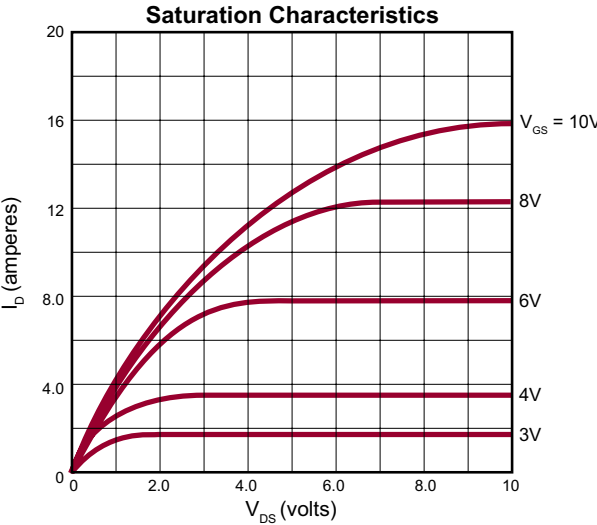
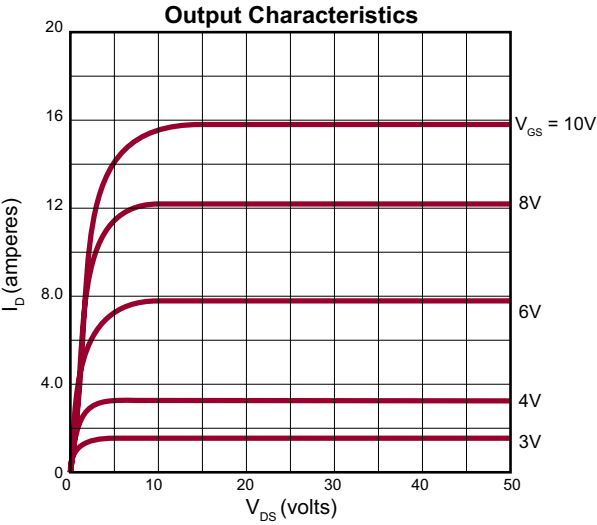
Notes:

1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300 μs pulse, 2% duty cycle.)
2. All A.C. parameters sample tested.

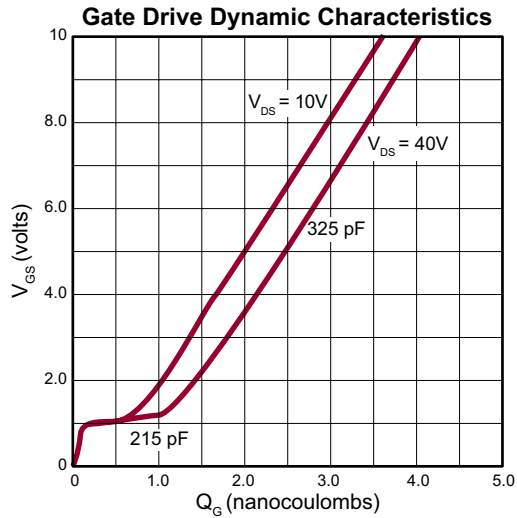
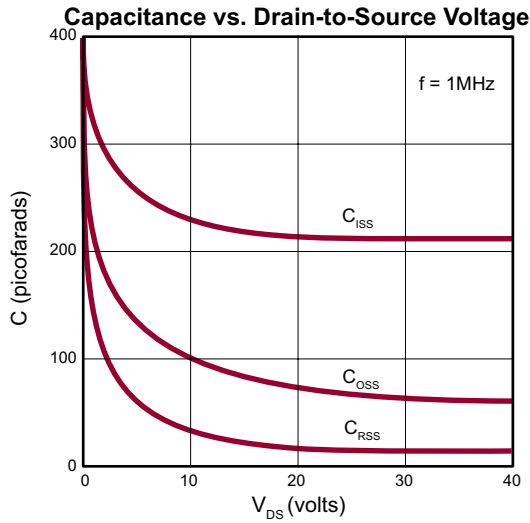
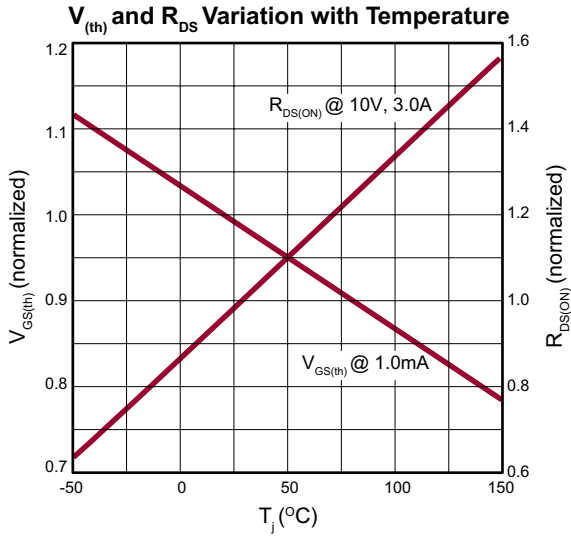
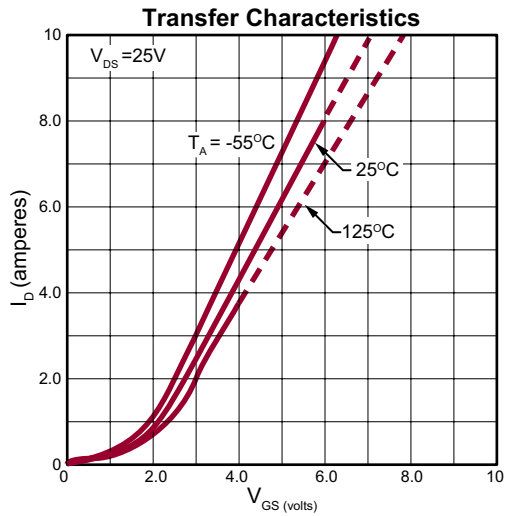
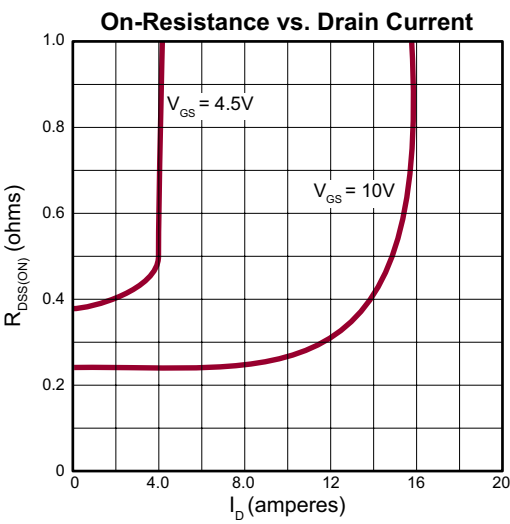
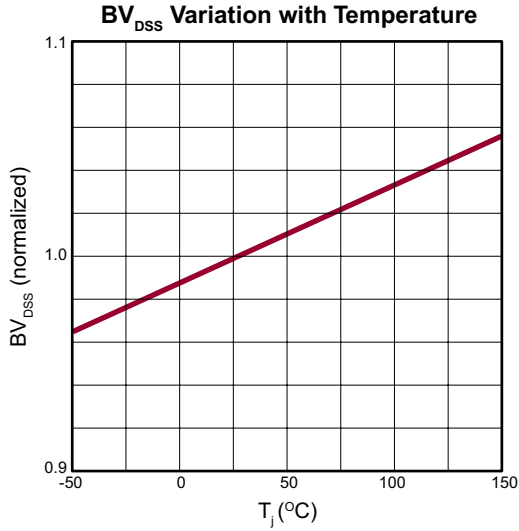
Switching Waveforms and Test Circuit



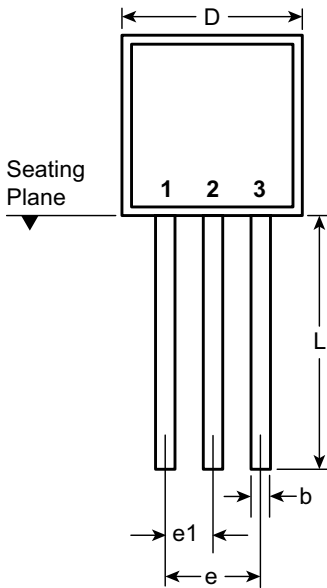
Typical Performance Curves



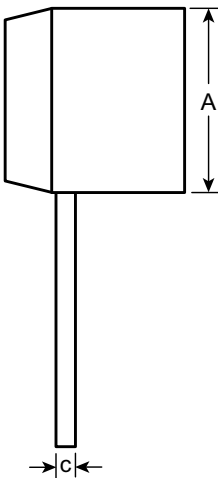
Typical Performance Curves (cont.)



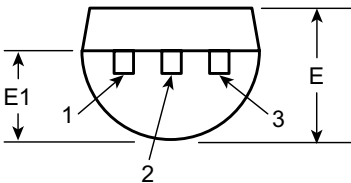
3-Lead TO-92 Package Outline (N3)



Front View



Side View

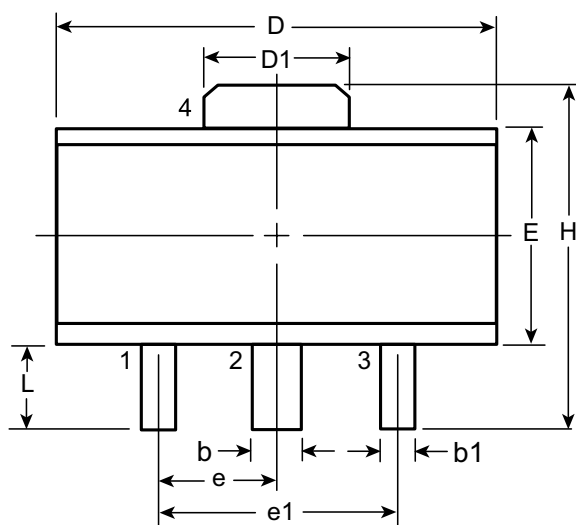


Bottom View

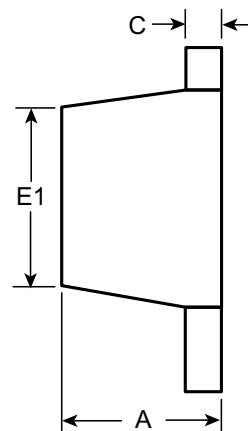
Symbol		A	b	c	D	E	E1	e	e1	L
Dimensions (inches)	MIN	.170	.014 [†]	.014 [†]	.175	.125	.080	.095	.045	.500
	NOM	-	-	-	-	-	-	-	-	-
	MAX	.210	.022 [†]	.022 [†]	.205	.165	.105	.105	.055	.610 [*]

JEDEC Registration TO-92.
* This dimension is not specified in the JEDEC drawing.
† This dimension differs from the JEDEC drawing.
Drawings not to scale.
Supertex Doc.#: DSPD-3TO92N3, Version E041009.

3-Lead TO-243AA (SOT-89) Package Outline (N8)



Top View



Side View

Symbol		A	b	b1	C	D	D1	E	E1	e	e1	H	L
Dimensions (mm)	MIN	1.40	0.44	0.36	0.35	4.40	1.62	2.29	2.00 [†]	1.50 BSC	3.00 BSC	3.94	0.73 [†]
	NOM	-	-	-	-	-	-	-	-			-	-
	MAX	1.60	0.56	0.48	0.44	4.60	1.83	2.60	2.29			4.25	1.20

JEDEC Registration TO-243, Variation AA, Issue C, July 1986.

[†] This dimension differs from the JEDEC drawing

Drawings not to scale.

Supertex Doc. #: DSPD-3TO243AAN8, Version F111010.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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